

STM32WL_QFN48_4Layers_Ref_Board

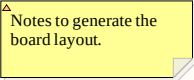
MB1720

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- Sheet 2: STM32WL_QFN48_4Layers_Ref_Board.SchDoc

Legend

- General comment such as function title, configuration, ...
- Text to be added to silkscreen.
- Warning text.



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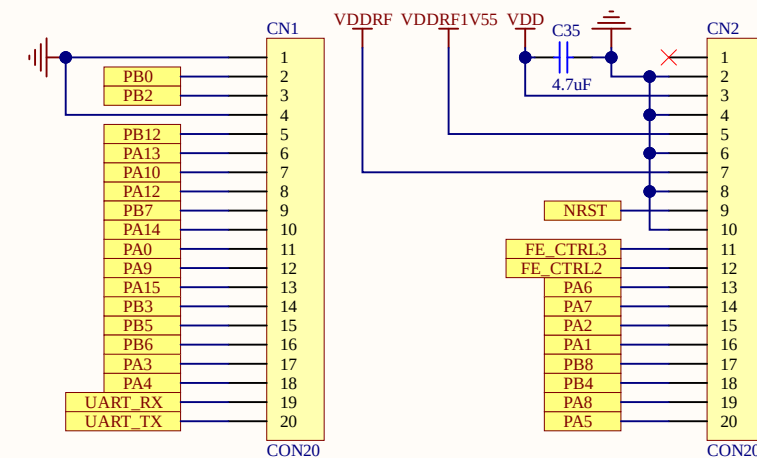
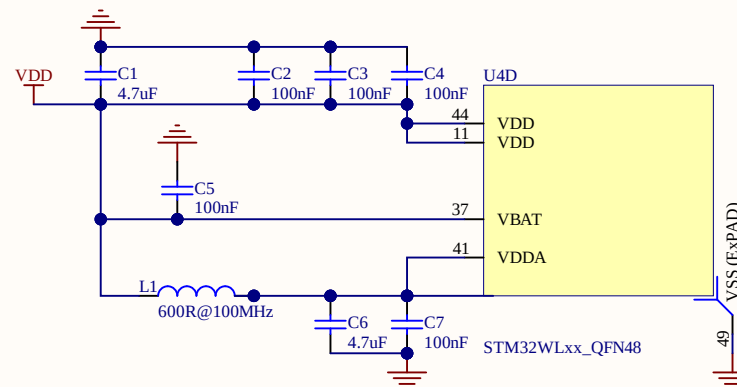
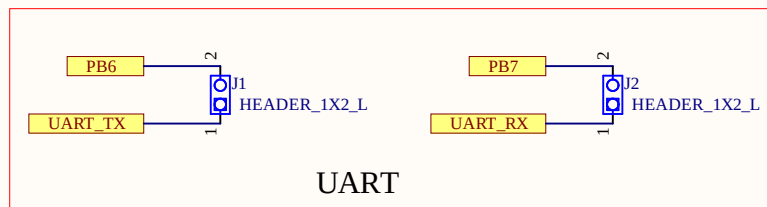
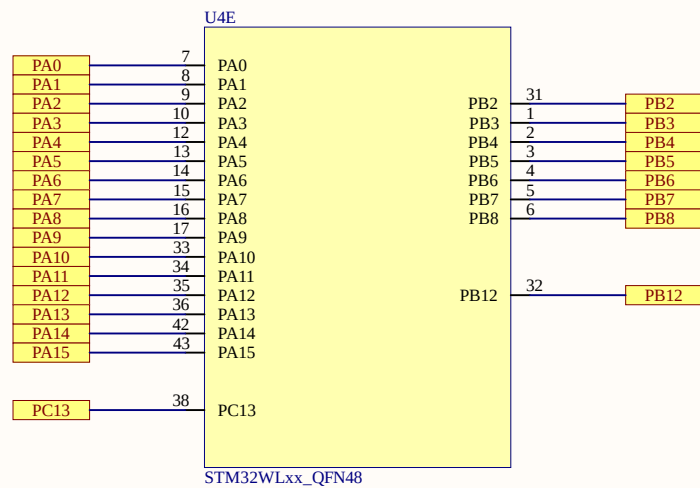
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STM32WL_QFN48_4Layers_Ref_Board.SchDoc

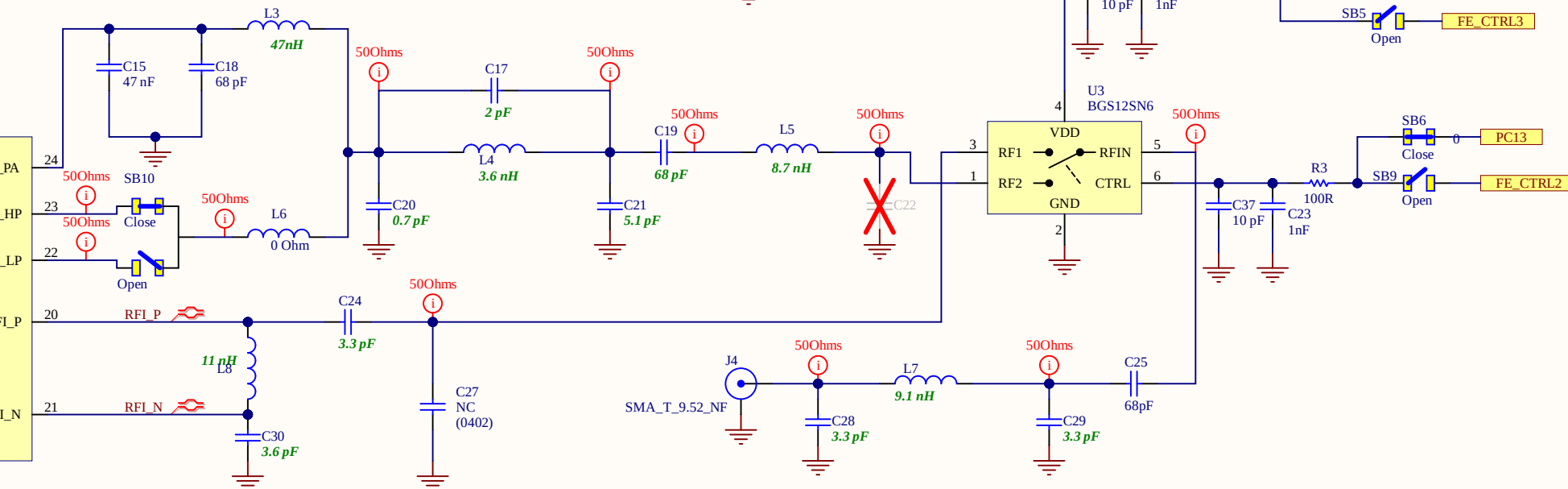
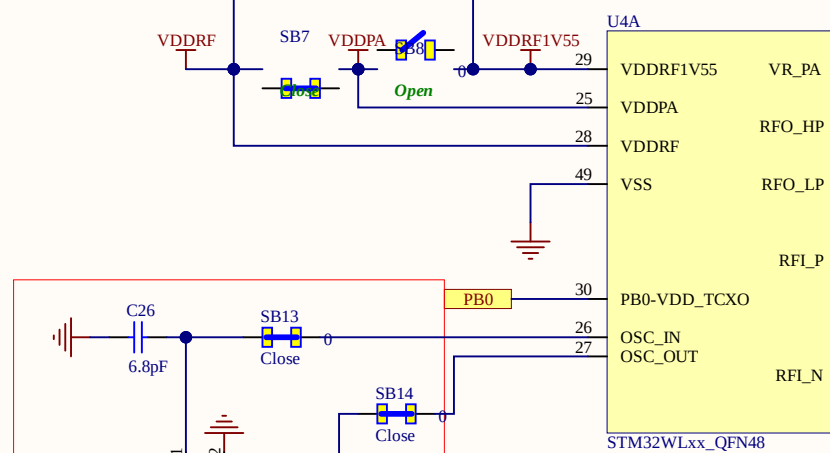
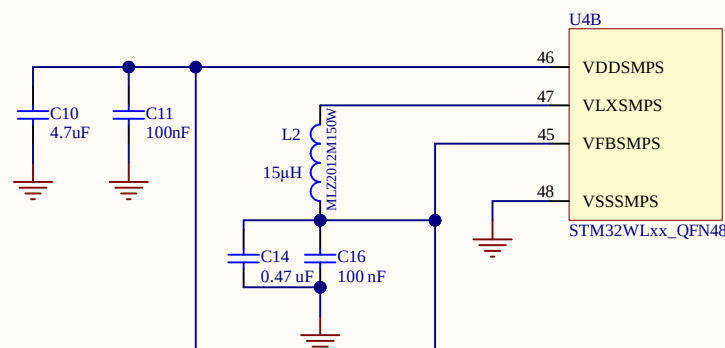
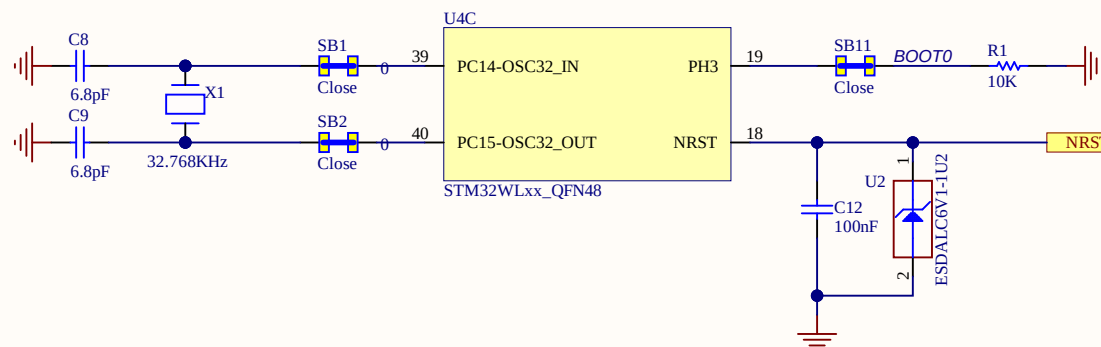


Title: Schematic sheet title to update		
Project: STM32WL_QFN48_4Layers_Ref_Board		
Variant: HighBand_HighPower		
Revision: A-01	Reference: MB1720	
Size: A4	Date: 29-03-2022	Sheet: 1 of 2





Connectors from daughter board (TOP LAYER)



With thermal barrier

capacitors close to STM32WL

Notes:

RF BoMHighBand_HighPower
RF components:
- RF High-Q muRata GJM15 series for capacitors
- RF High-Q muRata LQW15AN series for inductors